

# KPHBM-2012CGKSEKC

2.0 x 1.25 mm SMD Chip LED Lamp



# **DESCRIPTIONS**

- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- . The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

### **FEATURES**

- 2.0 mm x 1.25 mm SMD LED, 0.45 mm max. thickness
- Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- · Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- · RoHS compliant

# **APPLICATIONS**

- Backlight
- · Status indicator
- · Home and smart appliances
- Wearable and portable devices
- · Healthcare applications

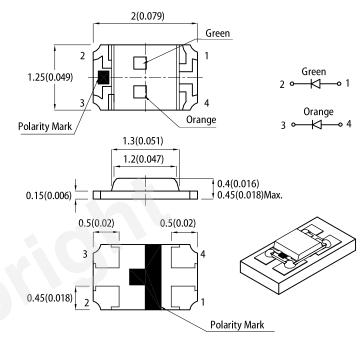
**SELECTION GUIDE** 

# **ATTENTION**

Observe precautions for handling electrostatic discharge sensitive devices

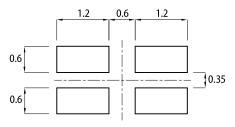


## **PACKAGE DIMENSIONS**



## RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- 17. All dimensions are in millimeters (inches).
  2. Tolerance is ±0.1(0.004") unless otherwise noted.
  3. The specifications, characteristics and technical data described in the datasheet are subject to
- The device has a single mounting surface. The device must be mounted according to the specifications.

#### Iv (mcd) @ 20mA [2] Viewing Angle [1] **Emitting Color Part Number** Lens Type (Material) 201/2 Min. Тур. 20 50 Green (AlGaInP) \*20 \*50 KPHBM-2012CGKSEKC 120° Water Clear 250 150 Super Bright Orange (AlGaInP) \*180 \*80

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

\* Luminous intensity value is traceable to CIE127-2007 standards.





# ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Symbol	Emitting Color	Value		11
			Тур.	Max.	Unit
Wavelength at Peak Emission I <sub>F</sub> = 20mA	$\lambda_{peak}$	Green Super Bright Orange	574 610	-	nm
Dominant Wavelength I <sub>F</sub> = 20mA	λ <sub>dom</sub> <sup>[1]</sup>	Green Super Bright Orange	570 605	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 20mA	Δλ	Green Super Bright Orange	20 29	-	nm
Capacitance	С	Green Super Bright Orange	15 15	-	pF
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Green Super Bright Orange	2.1 2.1	2.5 2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Green Super Bright Orange	-	10 10	μА
Temperature Coefficient of $\lambda_{peak}$ I <sub>F</sub> = 20mA, -10° C $\leq$ T $\leq$ 85° C	$TC_{\lambdapeak}$	Green Super Bright Orange	0.12 0.13	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ I <sub>F</sub> = 20mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>λdom</sub>	Green Super Bright Orange	0.08 0.06	-	nm/°C
Temperature Coefficient of $V_F$ $I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>V</sub>	Green Super Bright Orange	-1.9 -1.9	-	mV/°C

### Notes:

# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Va	I I mid	
		Green	Super Bright Orange	Unit
Power Dissipation	$P_D$	75	75	mW
Reverse Voltage	V <sub>R</sub>	5	5	V
Junction Temperature	T <sub>j</sub>	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 to	°C	
Storage Temperature	T <sub>stg</sub>	-40 to	°C	
DC Forward Current	I <sub>F</sub>	30	30	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	150	195	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> [2]	620	600	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	500	470	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. R<sub>Ib. JA</sub>, R<sub>Ib. US</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



Nuces.

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)

2. Forward voltage: ±0.1V.

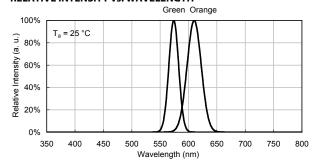
3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

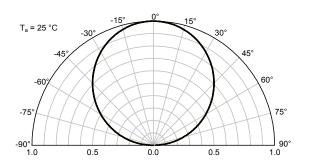


# **TECHNICAL DATA**

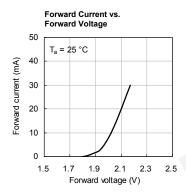
# **RELATIVE INTENSITY vs. WAVELENGTH**

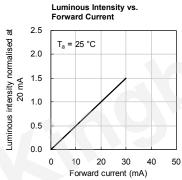


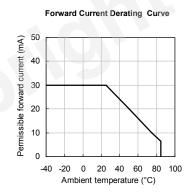
## **SPATIAL DISTRIBUTION**

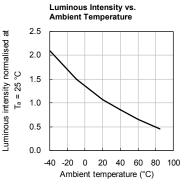


# **GREEN**

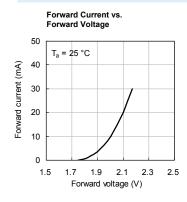


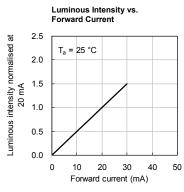


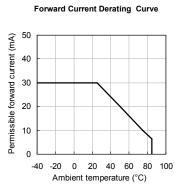


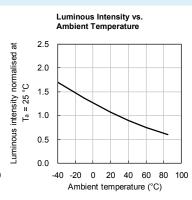


# **SUPER BRIGHT ORANGE**







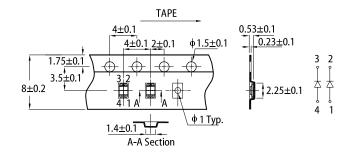




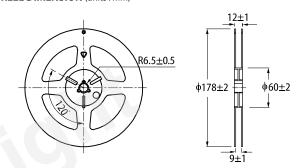
#### REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

#### 300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 .25°C 50 100 150 200 250 300 Time

## TAPE SPECIFICATIONS (units:mm)



## **REEL DIMENSION** (units: mm)



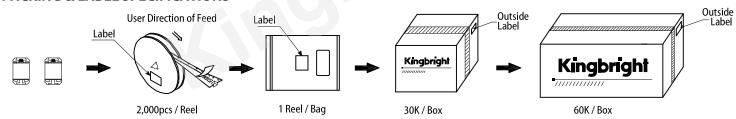
- Notes:

  1. Don't cause stress to the LEDs while it is exposed to high temperature.

  2. The maximum number of reflow soldering passes is 2 times.

  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

### PACKING & LABEL SPECIFICATIONS





# **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheet for the updated specifications.

  When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

  The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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